

General Description

The 044N10 is N-Channel MOSFET, It has specifically been designed to minimize input capacitance and gate charge. The device is therefore suitable in advanced high-efficiency switching applications.

100V N-Channel MOSFET

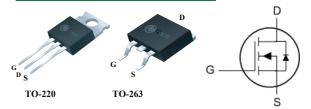
Product Summary

BVDSS	RDSON	ID
100V	4.5mΩ	160A

Applications

- Motor Control
- DC-DC converters
- Switching applications

TO-220/263 Pin Configuration



Туре	Package	Marking
CMP044N10	TO-220	CMP044N10
CMB044N10	TO-263	CMB044N10

Features

- Minimize input capacitance and gate charge
- 100% avalanche tested

Absolute Maximum Ratings

• Low On-Resistance

Symbol	Parameter	Rating	Units	
V _{DS}	Drain-Source Voltage	100	V	
V _{GS}	Gate-Source Voltage	±20	V	
I _D @T _C =25℃	Continuous Drain Current	160	A	
I _D @T _C =100℃	Continuous Drain Current	115	A	
I _{DM}	Pulsed Drain Current	640	A	
EAS	Single Pulse Avalanche Energy	1330	mJ	
P _D @T _C =25℃	Total Power Dissipation	260	W	
T _{STG}	Storage Temperature Range	-55 to 175	°C	
TJ	Operating Junction Temperature Range	-55 to 175	°C	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit	
R _{θJA}	Thermal Resistance Junction-ambient		62.5	°C/W	
R _{θJC}	Thermal Resistance Junction-case		1.0	°C/W	



100V N-Channel MOSFET

Electrical Characteristics (T_J=25 $^\circ\!\!\mathbb{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =20A			4.5	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D =250uA	2		4	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V, V _{GS} =0V			1	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = ±20V , V_{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =10V , I _D =20A		32		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		4.2		Ω
Qg	Total Gate Charge	I _D =100A		49		
Q _{gs}	Gate-Source Charge	V _{DD} =50V		20		nC
Q _{gd}	Gate-Drain Charge	V _{GS} =10V		10		
T _{d(on)}	Turn-On Delay Time	V _{DD} =50V		30		
Tr	Rise Time	I _D =100A		50		20
T _{d(off)}	Turn-Off Delay Time	R _G =6Ω		42		ns
T _f	Fall Time	V _{GS} =10V		14		
C _{iss}	Input Capacitance			6700		
C _{oss}	Output Capacitance	V_{DS} =50V , V_{GS} =0V , f=1MHz		2300		pF
C _{rss}	Reverse Transfer Capacitance			19		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	$V_G=V_D=0V$, Force Current			160	А
I _{SM}	Pulsed Source Current				640	А
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =50A , TJ=25℃			1.2	V

Note :

This product has been designed and qualified for the counsumer market.

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